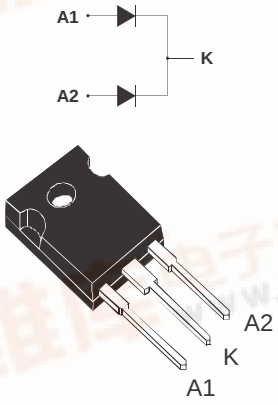
STPS40L15CW

LOW DROP OR-ing POWER SCHOTTKY DIODE

MAJOR PRODUCT CHARACTERISTICS

$I_{F(AV)}$	2 x 20 A
V_{RRM}	15 V
Tj (max)	150°C
V_F (max)	0.33 V



TO-247

FEATURES AND BENEFITS

- VERY LOW FORWARD VOLTAGE DROP FOR LESS POWER DISSIPATION AND REDUCED HEATSINK SIZE
- REVERSE VOLTAGE SUITED TO OR-ing OF 3V, 5V and 12V RAILS

DESCRIPTION

Dual center tap schottky rectifier packaged in TO-247, this device is especially intended for use as OR-ing diode in fault tolerant power supply equipments.

ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage			15	V
$I_{F(RMS)}$	RMS forward current			30	A
$I_{F(AV)}$	Average forward current	Tcase = 140°C δ = 1	Total	40	A
			Per diode	20	
I_{FSM}	Surge non repetitive forward current	tp = 10 ms Sinusoidal		310	A
I_{RRM}	Peak repetitive reverse current	tp = 2 µs F = 1kHz		2	A
I_{RSM}	Non repetitive peak reverse current	tp = 100 µs		3	A
T_{stg}	Storage temperature range			- 65 to + 150	°C
T_j	Maximum operating junction temperature *			150	°C
dV/dt	Critical rate of rise of reverse voltage			10000	V/µs

* : $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ thermal runaway condition for a diode on its own heatsink

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{th}(j\text{-}c)$	Junction to case	Per diode	1.6	°C/W
		Total	0.85	
$R_{th\ (c)}$		Coupling	0.1	°C/W

STATIC ELECTRICAL CHARACTERISTICS (Per diode)

Symbol	Parameter	Tests Conditions		Min.	Typ.	Max.	Unit
I_R *	Reverse leakage current	Tj = 25°C	$V_R = V_{RRM}$			6	mA
		Tj = 100°C			200	500	
V_F *	Forward voltage drop	Tj = 25°C	I_F = 19 A			0.41	V
		Tj = 25°C	I_F = 40 A			0.52	
		Tj = 125°C	I_F = 19 A		0.28	0.33	
		Tj = 125°C	I_F = 40 A		0.42	0.50	

Pulse test : * tp = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation :
$P = 0.18 \times I_{F(AV)} + 0.008\ I_F{}^2{}_{(RMS)}$

Fig. 1: Average forward power dissipation versus average forward current (per diode).

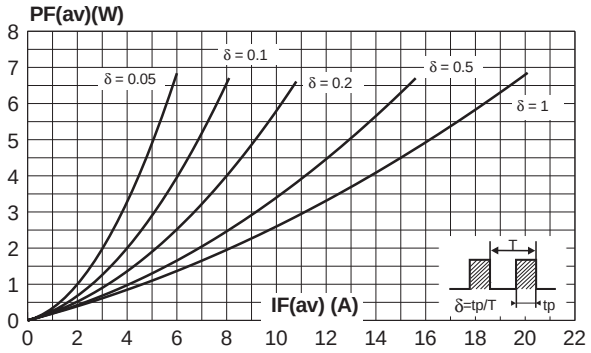


Fig. 2: Average forward current versus ambient temperature (δ=1, per diode).

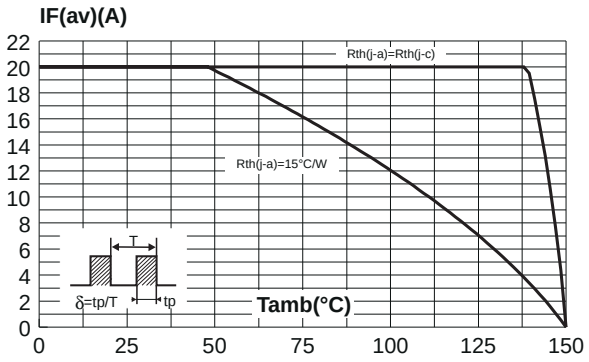


Fig. 3: Non repetitive surge peak forward current versus overload duration (maximum values per diode).

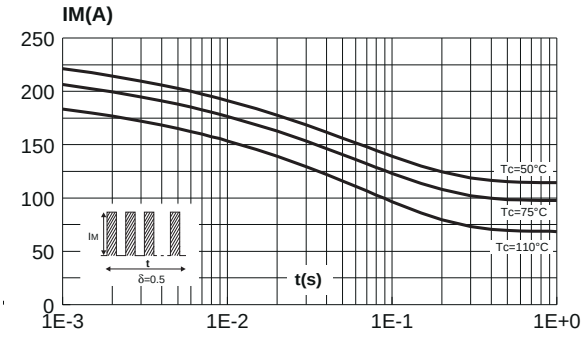


Fig. 4: Relative variation of thermal impedance junction to case versus pulse duration (per diode).

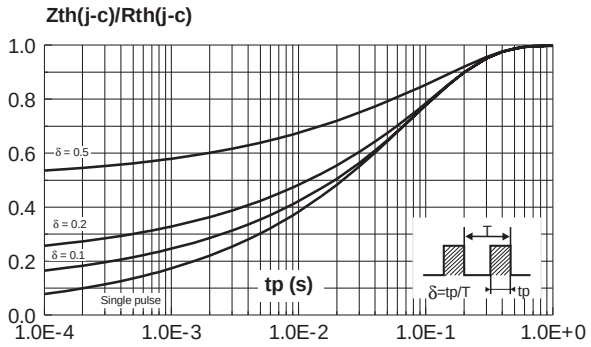


Fig. 5: Reverse leakage current versus reverse voltage applied (typical values per diode).

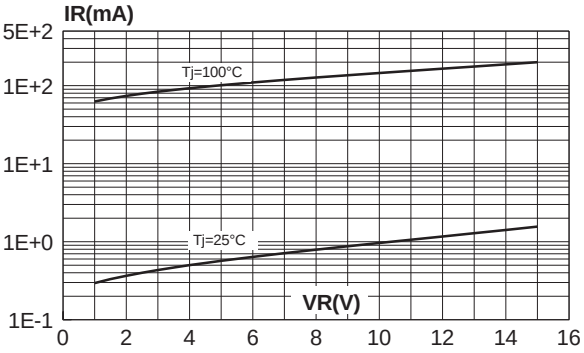


Fig. 6: Junction capacitance versus reverse voltage applied (typical values per diode).

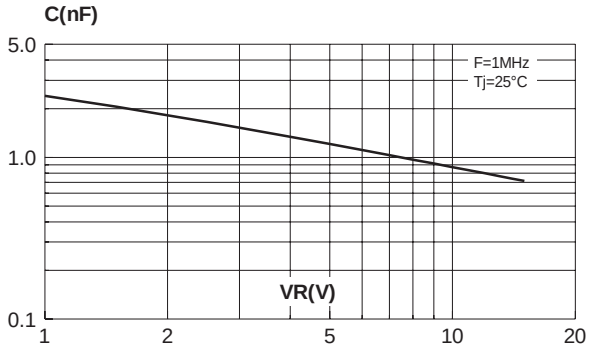


Fig. 7: Forward voltage drop versus forward current (typical values per diode).

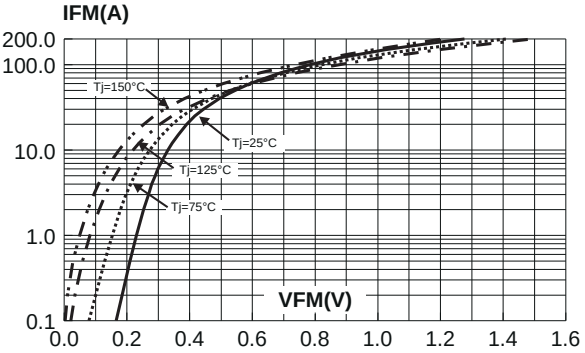
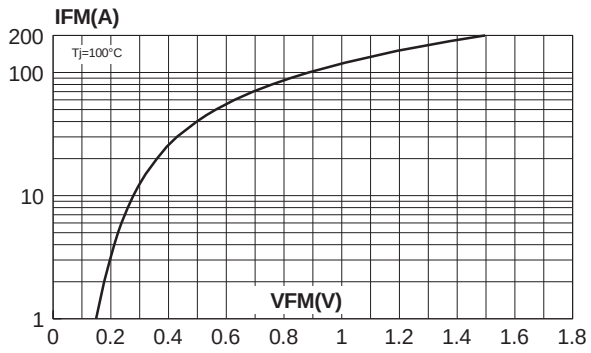
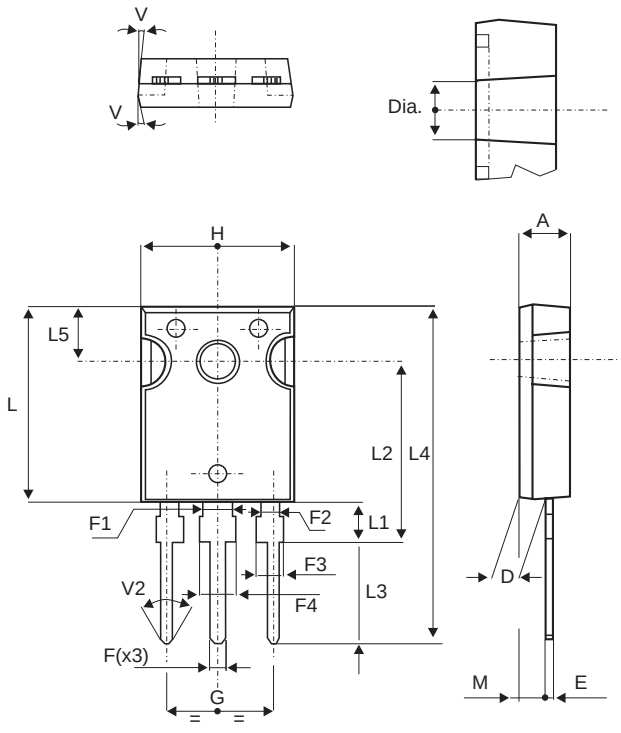


Fig. 8: Forward voltage drop versus forward current (typical maximum per diode).



PACKAGE MECHANICAL DATA

TO-247



REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.85		5.15	0.191		0.203
D	2.20		2.60	0.086		0.102
E	0.40		0.80	0.015		0.031
F	1.00		1.40	0.039		0.055
F1		3.00			0.118	
F2		2.00			0.078	
F3	2.00		2.40	0.078		0.094
F4	3.00		3.40	0.118		0.133
G		10.90			0.429	
H	15.45		15.75	0.608		0.620
L	19.85		20.15	0.781		0.793
L1	3.70		4.30	0.145		0.169
L2		18.50			0.728	
L3	14.20		14.80	0.559		0.582
L4		34.60			1.362	
L5		5.50			0.216	
M	2.00		3.00	0.078		0.118
V		5°			5°	
V2		60°			60°	
Dia.	3.55		3.65	0.139		0.143

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS40L15CW	STPS40L15CW	TO-247	4.4 g.	30	Tube

- Cooling method : by conduction (C)
- Recommended torque value : 0.8 N.m.
- Maximum torque value : 1.0 N.m.
- Epoxy meets UL94,V0